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Intel - 5SGSED8N3F45I3LN Datasheet



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Understanding <u>Embedded - FPGAs (Field</u> <u>Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

| Product Status | Obsolete |
|--------------------------------|---|
| Number of LABs/CLBs | 262400 |
| Number of Logic Elements/Cells | 695000 |
| Total RAM Bits | 51200000 |
| Number of I/O | 840 |
| Number of Gates | - |
| Voltage - Supply | 0.82V ~ 0.88V |
| Mounting Type | Surface Mount |
| Operating Temperature | -40°C ~ 100°C (TJ) |
| Package / Case | 1932-BBGA, FCBGA |
| Supplier Device Package | 1932-FBGA, FC (45x45) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/5sgsed8n3f45i3ln |
| | |

Email: info@E-XFL.COM

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| | | | | shoon and | le entening | | (| -, |
|---------------------|----|---------|-----|-----------|-------------|---------|--------------|-----|
| Transceiver Speed | | | | Core Spe | ed Grade | | | |
| Grade | C1 | C2, C2L | C3 | C4 | 12, 12L | 13, 13L | I 3YY | 14 |
| 3 | | Yes | Yes | Yes | | Yes | Yes (4) | Yes |
| GX channel—8.5 Gbps | | 165 | 165 | 165 | | 163 | 163 17 | 165 |

Table 1. Stratix V GX and GS Commercial and Industrial Speed Grade Offering ^{(1), (2), (3)} (Part 2 of 2)

Notes to Table 1:

(1) C = Commercial temperature grade; I = Industrial temperature grade.

(2) Lower number refers to faster speed grade.

(3) C2L, I2L, and I3L speed grades are for low-power devices.

(4) I3YY speed grades can achieve up to 10.3125 Gbps.

Table 2 lists the industrial and commercial speed grades for the Stratix V GT devices. **Table 2. Stratix V GT Commercial and Industrial Speed Grade Offering** ⁽¹⁾, ⁽²⁾

| Transaction Oracle Oracle | Core Speed Grade | | | | | | | |
|--|------------------|-----|-----|-----|--|--|--|--|
| Transceiver Speed Grade | C1 | C2 | 12 | 13 | | | | |
| 2 GX channel—12.5 Gbps GT channel—28.05 Gbps | Yes | Yes | _ | _ | | | | |
| 3 GX channel—12.5 Gbps GT channel—25.78 Gbps | Yes | Yes | Yes | Yes | | | | |

Notes to Table 2:

(1) C = Commercial temperature grade; I = Industrial temperature grade.

(2) Lower number refers to faster speed grade.

Absolute Maximum Ratings

Absolute maximum ratings define the maximum operating conditions for Stratix V devices. The values are based on experiments conducted with the devices and theoretical modeling of breakdown and damage mechanisms. The functional operation of the device is not implied for these conditions.



Conditions other than those listed in Table 3 may cause permanent damage to the device. Additionally, device operation at the absolute maximum ratings for extended periods of time may have adverse effects on the device.

| Table 3. | Absolute | Maximum | Ratings | for Stratix \ | / Devices | (Part 1 of 2) |
|----------|----------|---------|----------------|---------------|-----------|---------------|
|----------|----------|---------|----------------|---------------|-----------|---------------|

| Symbol | Description | Minimum | Maximum | Unit |
|---------------------|--|---------|---------|------|
| V _{CC} | Power supply for core voltage and periphery circuitry | -0.5 | 1.35 | V |
| V _{CCPT} | Power supply for programmable power technology | -0.5 | 1.8 | V |
| V _{CCPGM} | Power supply for configuration pins | -0.5 | 3.9 | V |
| V _{CC_AUX} | Auxiliary supply for the programmable power technology | -0.5 | 3.4 | V |
| V _{CCBAT} | Battery back-up power supply for design security volatile key register | -0.5 | 3.9 | V |
| V _{CCPD} | I/O pre-driver power supply | -0.5 | 3.9 | V |
| V _{CCIO} | I/O power supply | -0.5 | 3.9 | V |

This section lists the functional operating limits for the AC and DC parameters for Stratix V devices. Table 6 lists the steady-state voltage and current values expected from Stratix V devices. Power supply ramps must all be strictly monotonic, without plateaus.

Table 6. Recommended Operating Conditions for Stratix V Devices (Part 1 of 2)

| Symbol | Description | Condition | Min ⁽⁴⁾ | Тур | Max ⁽⁴⁾ | Unit |
|----------------------------------|---|------------|--------------------|------|--------------------|------|
| | Core voltage and periphery circuitry power supply (C1, C2, I2, and I3YY speed grades) | _ | 0.87 | 0.9 | 0.93 | V |
| V _{CC} | Core voltage and periphery circuitry power supply (C2L, C3, C4, I2L, I3, I3L, and I4 speed grades) ⁽³⁾ | _ | 0.82 | 0.85 | 0.88 | V |
| V _{CCPT} | Power supply for programmable power technology | _ | 1.45 | 1.50 | 1.55 | V |
| V _{CC_AUX} | Auxiliary supply for the programmable power technology | _ | 2.375 | 2.5 | 2.625 | V |
| VI (1) | I/O pre-driver (3.0 V) power supply | _ | 2.85 | 3.0 | 3.15 | V |
| V _{CCPD} ⁽¹⁾ | I/O pre-driver (2.5 V) power supply | _ | 2.375 | 2.5 | 2.625 | V |
| | I/O buffers (3.0 V) power supply | | 2.85 | 3.0 | 3.15 | V |
| | I/O buffers (2.5 V) power supply | _ | 2.375 | 2.5 | 2.625 | V |
| | I/O buffers (1.8 V) power supply | | 1.71 | 1.8 | 1.89 | V |
| V _{CCIO} | I/O buffers (1.5 V) power supply | _ | 1.425 | 1.5 | 1.575 | V |
| | I/O buffers (1.35 V) power supply | _ | 1.283 | 1.35 | 1.45 | V |
| | I/O buffers (1.25 V) power supply | _ | 1.19 | 1.25 | 1.31 | V |
| | I/O buffers (1.2 V) power supply | _ | 1.14 | 1.2 | 1.26 | V |
| | Configuration pins (3.0 V) power supply | _ | 2.85 | 3.0 | 3.15 | V |
| V _{CCPGM} | Configuration pins (2.5 V) power supply | _ | 2.375 | 2.5 | 2.625 | V |
| | Configuration pins (1.8 V) power supply | _ | 1.71 | 1.8 | 1.89 | V |
| V _{CCA_FPLL} | PLL analog voltage regulator power supply | _ | 2.375 | 2.5 | 2.625 | V |
| V _{CCD_FPLL} | PLL digital voltage regulator power supply | _ | 1.45 | 1.5 | 1.55 | V |
| V _{CCBAT} (2) | Battery back-up power supply (For design security volatile key register) | _ | 1.2 | _ | 3.0 | V |
| VI | DC input voltage | _ | -0.5 | _ | 3.6 | V |
| V ₀ | Output voltage | — | 0 | — | V _{CCIO} | V |
| т | Operating junction temperature | Commercial | 0 | — | 85 | °C |
| TJ | Operating junction temperature | Industrial | -40 | _ | 100 | °C |

| | | | Calibration Accuracy | | | | | |
|---|--|--|----------------------|------------|----------------|------------|------|--|
| Symbol | Description | Conditions | C1 | C2,12 | C3,I3, I3YY | C4,14 | Unit | |
| 50-Ω R _S | Internal series termination with calibration (50- Ω setting) | V _{CCI0} = 3.0, 2.5, 1.8, 1.5, 1.2 V | ±15 | ±15 | ±15 | ±15 | % | |
| 34-Ω and 40-Ω R _S | Internal series termination with calibration (34- Ω and 40- Ω setting) | V _{CCI0} = 1.5, 1.35, 1.25, 1.2 V | ±15 | ±15 | ±15 | ±15 | % | |
| 48-Ω, 60-Ω, 80-Ω, and 240-Ω R _S | Internal series termination with calibration (48- Ω , 60- Ω , 80- Ω , and 240- Ω setting) | V _{CCI0} = 1.2 V | ±15 | ±15 | ±15 | ±15 | % | |
| 50-Ω R _T | Internal parallel termination with calibration (50-Ω setting) | V _{CCIO} = 2.5, 1.8, 1.5, 1.2 V | -10 to +40 | -10 to +40 | -10 to +40 | -10 to +40 | % | |
| 20- $Ω$, 30- $Ω$, 40- $Ω$,60- $Ω$, and 120- $Ω$ R _T | Internal parallel termination with calibration ($20 \cdot \Omega$, $30 \cdot \Omega$, $40 \cdot \Omega$, $60 \cdot \Omega$, and $120 \cdot \Omega$ setting) | V _{CCI0} = 1.5, 1.35, 1.25 V | -10 to +40 | -10 to +40 | -10 to +40 | -10 to +40 | % | |
| 60-Ω and 120-Ω R_T | Internal parallel termination with calibration (60- Ω and 120- Ω setting) | V _{CCI0} = 1.2 | -10 to +40 | -10 to +40 | -10 to +40 | -10 to +40 | % | |
| $\begin{array}{l} \textbf{25-}\Omega\\ \textbf{R}_{S_left_shift} \end{array}$ | Internal left shift series termination with calibration (25- Ω R _{S_left_shift} setting) | V _{CCI0} = 3.0, 2.5, 1.8, 1.5, 1.2 V | ±15 | ±15 | ±15 | ±15 | % | |

| Table 11. OCT Calibration Accurat | y Specifications for Stratix V Devices ⁽¹⁾ (| (Part 2 of 2) |
|-----------------------------------|---|---------------|
|-----------------------------------|---|---------------|

Note to Table 11:

(1) OCT calibration accuracy is valid at the time of calibration only.

Table 12 lists the Stratix V OCT without calibration resistance to PVT changes.

| | | | Re | esistance | Tolerance | 1 | |
|-----------------------------|--|----------------------------|-----|-----------|-----------------|--------|------|
| Symbol | Description | Conditions | C1 | C2,I2 | C3, I3, I3YY | C4, I4 | Unit |
| 25-Ω R, 50-Ω R _S | Internal series termination without calibration (25- Ω setting) | $V_{CCIO} = 3.0$ and 2.5 V | ±30 | ±30 | ±40 | ±40 | % |
| 25-Ω R _S | Internal series termination without calibration (25-Ω setting) | $V_{CCIO} = 1.8$ and 1.5 V | ±30 | ±30 | ±40 | ±40 | % |
| 25-Ω R _S | Internal series termination without calibration (25-Ω setting) | V _{CCI0} = 1.2 V | ±35 | ±35 | ±50 | ±50 | % |

| Symbol/ Description | Conditions | Transceiver Speed Grade 1 | | Transceiver Speed Grade 2 | | | Transceiver Speed Grade 3 | | | Unit | |
|----------------------------|------------|------------------------------|-----|------------------------------|-----|-----|------------------------------|-----|-----|------|----|
| Description | | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | |
| t _{pll_lock} (16) | _ | | | 10 | | — | 10 | — | | 10 | μs |

Table 23. Transceiver Specifications for Stratix V GX and GS Devices ⁽¹⁾ (Part 7 of 7)

Notes to Table 23:

(2) The reference clock common mode voltage is equal to the V_{CCR_GXB} power supply level.

(3) This supply must be connected to 1.0 V if the transceiver is configured at a data rate > 6.5 Gbps, and to 1.05 V if configured at a data rate > 10.3 Gbps when DFE is used. For data rates up to 6.5 Gbps, you can connect this supply to 0.85 V.

- (4) This supply follows VCCR_GXB.
- (5) The device cannot tolerate prolonged operation at this absolute maximum.
- (6) The differential eye opening specification at the receiver input pins assumes that **Receiver Equalization** is disabled. If you enable **Receiver Equalization**, the receiver circuitry can tolerate a lower minimum eye opening, depending on the equalization level.
- (7) The Quartus II software automatically selects the appropriate slew rate depending on the configured data rate or functional mode.
- (8) The input reference clock frequency options depend on the data rate and the device speed grade.
- (9) The line data rate may be limited by PCS-FPGA interface speed grade.
- (10) Refer to Figure 1 for the GX channel AC gain curves. The total effective AC gain is the AC gain minus the DC gain.
- (11) t_{LTR} is the time required for the receive CDR to lock to the input reference clock frequency after coming out of reset.
- (12) t_{LTD} is time required for the receiver CDR to start recovering valid data after the rx_is_lockedtodata signal goes high.
- (13) t_{LTD_manual} is the time required for the receiver CDR to start recovering valid data after the rx_is_lockedtodata signal goes high when the CDR is functioning in the manual mode.
- (14) $t_{LTR_LTD_manual}$ is the time the receiver CDR must be kept in lock to reference (LTR) mode after the rx_is_lockedtoref signal goes high when the CDR is functioning in the manual mode.
- (15) $t_{pll_powerdown}$ is the PLL powerdown minimum pulse width.
- (16) t_{pll lock} is the time required for the transmitter CMU/ATX PLL to lock to the input reference clock frequency after coming out of reset.
- (17) To calculate the REFCLK rms phase jitter requirement for PCIe at reference clock frequencies other than 100 MHz, use the following formula: REFCLK rms phase jitter at f(MHz) = REFCLK rms phase jitter at 100 MHz × 100/f.
- (18) The maximum peak to peak differential input voltage V_{ID} after device configuration is equal to 4 × (absolute V_{MAX} for receiver pin V_{ICM}).
- (19) For ES devices, R_{BEF} is 2000 $\Omega \pm 1\%$.
- (20) To calculate the REFCLK phase noise requirement at frequencies other than 622 MHz, use the following formula: REFCLK phase noise at f(MHz) = REFCLK phase noise at 622 MHz + 20*log(f/622).
- (21) SFP/+ optical modules require the host interface to have RD+/- differentially terminated with 100 Ω. The internal OCT feature is available after the Stratix V FPGA configuration is completed. Altera recommends that FPGA configuration is completed before inserting the optical module. Otherwise, minimize unnecessary removal and insertion with unconfigured devices.
- (22) Refer to Figure 2.
- (23) For oversampling designs to support data rates less than the minimum specification, the CDR needs to be in LTR mode only.
- (24) I3YY devices can achieve data rates up to 10.3125 Gbps.
- (25) When you use fPLL as a TXPLL of the transceiver.
- (26) REFCLK performance requires to meet transmitter REFCLK phase noise specification.
- (27) Minimum eye opening of 85 mV is only for the unstressed input eye condition.

⁽¹⁾ Speed grades shown in Table 23 refer to the PMA Speed Grade in the device ordering code. The maximum data rate could be restricted by the Core/PCS speed grade. Contact your Altera Sales Representative for the maximum data rate specifications in each speed grade combination offered. For more information about device ordering codes, refer to the Stratix V Device Overview.

Table 24 shows the maximum transmitter data rate for the clock network.

Table 24. Clock Network Maximum Data Rate Transmitter Specifications (1)

| | | ATX PLL | | | CMU PLL ⁽²⁾ |) | | fPLL | |
|-----------------------------------|----------------------------------|--------------------------|--|----------------------------------|--------------------------|-------------------------------|----------------------------------|--------------------------|-------------------------------|
| Clock Network | Non- bonded Mode (Gbps) | Bonded Mode (Gbps) | Channel Span | Non- bonded Mode (Gbps) | Bonded Mode (Gbps) | Channel Span | Non- bonded Mode (Gbps) | Bonded Mode (Gbps) | Channel Span |
| x1 ⁽³⁾ | 14.1 | — | 6 | 12.5 | _ | 6 | 3.125 | _ | 3 |
| x6 ⁽³⁾ | _ | 14.1 | 6 | _ | 12.5 | 6 | _ | 3.125 | 6 |
| x6 PLL Feedback ⁽⁴⁾ | _ | 14.1 | Side- wide | _ | 12.5 | Side- wide | | _ | _ |
| xN (PCIe) | _ | 8.0 | 8 | _ | 5.0 | 8 | _ | _ | _ |
| VN (Native DHV ID) | 8.0 | 8.0 | Up to 13 channels above and below PLL | 7.99 | 7.99 | Up to 13 channels above | 3.125 | 3.125 | Up to 13 channels above |
| xN (Native PHY IP) | _ | 8.01 to 9.8304 | Up to 7 channels above and below PLL | 7.55 | 7.55 | and below PLL | 3.120 | 0.120 | and below PLL |

Notes to Table 24:

(1) Valid data rates below the maximum specified in this table depend on the reference clock frequency and the PLL counter settings. Check the MegaWizard message during the PHY IP instantiation.

(2) ATX PLL is recommended at 8 Gbps and above data rates for improved jitter performance.

(3) Channel span is within a transceiver bank.

(4) Side-wide channel bonding is allowed up to the maximum supported by the PHY IP.

| Table 28. Transceiver Specifications for Stratix V GT Devices (Part 4 of 5) ⁽¹⁾ |
|--|
|--|

| Symbol/ | Conditions | Transceiver Speed Grade 2 | | | | Fransceive Deed Grade | | Unit |
|--|--|------------------------------|-----|--------------------------------|--------|--------------------------|--------------------------------|------|
| Description | | Min | Тур | Max | Min | Тур | Max | |
| Data rate | GT channels | 19,600 | | 28,050 | 19,600 | | 25,780 | Mbps |
| Differential on-chip | GT channels | | 100 | _ | | 100 | | Ω |
| termination resistors | GX channels | | 1 | 1 | (8) | | 11 | |
| | GT channels | | 500 | _ | | 500 | — | mV |
| V_{OCM} (AC coupled) | GX channels | | 1 | 1 | (8) | | 11 | |
| Dies/Fall times | GT channels | _ | 15 | _ | | 15 | — | ps |
| Rise/Fall time | GX channels | | | | (8) | | 1 | |
| Intra-differential pair skew | GX channels | | | | (8) | | | |
| Intra-transceiver block transmitter channel-to- channel skew | GX channels | | | | (8) | | | |
| Inter-transceiver block transmitter channel-to- channel skew | GX channels | | | | (8) | | | |
| CMU PLL | · · · · · · | | | | | | | |
| Supported Data Range | — | 600 | — | 12500 | 600 | — | 8500 | Mbps |
| t _{pll_powerdown} (13) | — | 1 | — | — | 1 | _ | — | μs |
| t _{pll_lock} ⁽¹⁴⁾ | — | _ | — | 10 | _ | _ | 10 | μs |
| ATX PLL | | | | | | | | |
| | VCO post- divider L=2 | 8000 | _ | 12500 | 8000 | _ | 8500 | Mbps |
| | L=4 | 4000 | | 6600 | 4000 | _ | 6600 | Mbps |
| Supported Data Rate | L=8 | 2000 | — | 3300 | 2000 | - | 3300 | Mbps |
| Range for GX Channels | L=8, Local/Central Clock Divider =2 | 1000 | _ | 1762.5 | 1000 | _ | 1762.5 | Mbps |
| Supported Data Rate Range for GT Channels | VCO post- divider L=2 | 9800 | _ | 14025 | 9800 | _ | 12890 | Mbps |
| t _{pll_powerdown} ⁽¹³⁾ | — | 1 | — | — | 1 | — | — | μs |
| t _{pll_lock} ⁽¹⁴⁾ | — | | — | 10 | — | — | 10 | μs |
| fPLL | | | | | | | · · | |
| Supported Data Range | _ | 600 | | 3250/ 3.125 ⁽²³⁾ | 600 | _ | 3250/ 3.125 ⁽²³⁾ | Mbps |
| t _{pll_powerdown} (13) | | 1 | _ | | 1 | | | μs |

Figure 6 shows the Stratix V DC gain curves for GT channels.

Figure 6. DC Gain Curves for GT Channels

Transceiver Characterization

This section summarizes the Stratix V transceiver characterization results for compliance with the following protocols:

- Interlaken
- 40G (XLAUI)/100G (CAUI)
- 10GBase-KR
- QSGMII
- XAUI
- SFI
- Gigabit Ethernet (Gbe / GIGE)
- SPAUI
- Serial Rapid IO (SRIO)
- CPRI
- OBSAI
- Hyper Transport (HT)
- SATA
- SAS
- CEI

- XFI
- ASI
- HiGig/HiGig+
- HiGig2/HiGig2+
- Serial Data Converter (SDC)
- GPON
- SDI
- SONET
- Fibre Channel (FC)
- PCIe
- QPI
- SFF-8431

Download the Stratix V Characterization Report Tool to view the characterization report summary for these protocols.

Core Performance Specifications

This section describes the clock tree, phase-locked loop (PLL), digital signal processing (DSP), memory blocks, configuration, and JTAG specifications.

Clock Tree Specifications

Table 30 lists the clock tree specifications for Stratix V devices.

Table 30. Clock Tree Performance for Stratix V Devices (1)

| | Performance | | | | | | | | |
|------------------------------|-----------------------------|--------------------------|--------|------|--|--|--|--|--|
| Symbol | C1, C2, C2L, I2, and I2L | C3, I3, I3L, and I3YY | C4, I4 | Unit | | | | | |
| Global and Regional Clock | 717 | 650 | 580 | MHz | | | | | |
| Periphery Clock | 550 | 500 | 500 | MHz | | | | | |

Note to Table 30:

(1) The Stratix V ES devices are limited to 600 MHz core clock tree performance.

| Symbol | Parameter | Min | Тур | Max | Unit |
|---|---|------|---------|--|-----------|
| + (3) (4) | Input clock cycle-to-cycle jitter ($f_{REF} \ge 100 \text{ MHz}$) | _ | — | 0.15 | UI (p-p) |
| t _{INCCJ} ^{(3),} ⁽⁴⁾ | Input clock cycle-to-cycle jitter (f _{REF} < 100 MHz) | -750 | _ | +750 | ps (p-p) |
| t | Period Jitter for dedicated clock output (f_{OUT} \geq 100 MHz) | _ | _ | 175 ⁽¹⁾ | ps (p-p) |
| t _{outpj_dc} ⁽⁵⁾ | Period Jitter for dedicated clock output (f _{OUT} < 100 MHz) | _ | | 17.5 ⁽¹⁾ | mUI (p-p) |
| + (5) | Period Jitter for dedicated clock output in fractional PLL ($f_{0UT} \geq 100 \mbox{ MHz})$ | _ | _ | 250 ⁽¹¹⁾ , 175 ⁽¹²⁾ | ps (p-p) |
| t _{foutpj_dc} ⁽⁵⁾ | Period Jitter for dedicated clock output in fractional PLL (f _{OUT} < 100 MHz) | _ | _ | 25 ⁽¹¹⁾ , 17.5 ⁽¹²⁾ | mUI (p-p) |
| + | Cycle-to-Cycle Jitter for a dedicated clock output ($f_{OUT} \ge 100 \text{ MHz}$) | _ | _ | 175 | ps (p-p) |
| t _{outccj_dc} ⁽⁵⁾ | Cycle-to-Cycle Jitter for a dedicated clock output (f _{0UT} < 100 MHz) | _ | _ | 17.5 | mUI (p-p) |
| + <i>(5)</i> | Cycle-to-cycle Jitter for a dedicated clock output in fractional PLL (f_{OUT} \geq 100 MHz) | _ | _ | 250 ⁽¹¹⁾ , 175 ⁽¹²⁾ | ps (p-p) |
| t _{FOUTCCJ_DC} ⁽⁵⁾ | Cycle-to-cycle Jitter for a dedicated clock output in fractional PLL ($f_{OUT} < 100 \text{ MHz}$)+ | _ | _ | 25 ⁽¹¹⁾ , 17.5 ⁽¹²⁾ | mUI (p-p) |
| t _{outpj_io} (5), | Period Jitter for a clock output on a regular I/O in integer PLL (f_{OUT} \geq 100 MHz) | _ | _ | 600 | ps (p-p) |
| (8) | Period Jitter for a clock output on a regular I/O (f _{OUT} < 100 MHz) | _ | _ | 60 | mUI (p-p) |
| t _{FOUTPJ_IO} (5), | Period Jitter for a clock output on a regular I/O in fractional PLL ($f_{OUT} \ge 100 \text{ MHz}$) | _ | _ | 600 (10) | ps (p-p) |
| (8), (11) | Period Jitter for a clock output on a regular I/O in fractional PLL (f _{OUT} < 100 MHz) | _ | _ | 60 ⁽¹⁰⁾ | mUI (p-p) |
| t _{outccj_io} (5), | Cycle-to-cycle Jitter for a clock output on a regular I/O in integer PLL (f_{OUT} \geq 100 MHz) | _ | _ | 600 | ps (p-p) |
| (8) | Cycle-to-cycle Jitter for a clock output on a regular I/O in integer PLL (f_{OUT} < 100 MHz) | _ | _ | 60 ⁽¹⁰⁾ | mUI (p-p) |
| t _{foutccj_10} ^{(5),} | Cycle-to-cycle Jitter for a clock output on a regular I/O in fractional PLL ($f_{0UT} \geq 100 \mbox{ MHz})$ | _ | _ | 600 ⁽¹⁰⁾ | ps (p-p) |
| (8), (11) | Cycle-to-cycle Jitter for a clock output on a regular I/O in fractional PLL ($f_{OUT} < 100 \text{ MHz}$) | _ | _ | 60 | mUI (p-p) |
| t _{casc_outpj_dc} | Period Jitter for a dedicated clock output in cascaded PLLs (f_{0UT} \geq 100 MHz) | | _ | 175 | ps (p-p) |
| (5), (6) | Period Jitter for a dedicated clock output in cascaded PLLs (f _{OUT} < 100 MHz) | | _ | 17.5 | mUI (p-p) |
| f _{DRIFT} | Frequency drift after PFDENA is disabled for a duration of 100 μs | _ | _ | ±10 | % |
| dK _{BIT} | Bit number of Delta Sigma Modulator (DSM) | 8 | 24 | 32 | Bits |
| k _{value} | Numerator of Fraction | 128 | 8388608 | 2147483648 | |

Table 31. PLL Specifications for Stratix V Devices (Part 2 of 3)

| | | Resour | ces Used | | | Pe | erforman | ce | | | |
|---------------|---|--------|----------|-----|------------|-----|----------|---------|---------------------|-----|------|
| Memory | Mode | ALUTS | Memory | C1 | C2, C2L | C3 | C4 | 12, 12L | 13, 13L, 13YY | 14 | Unit |
| | Single-port, all supported widths | 0 | 1 | 700 | 700 | 650 | 550 | 700 | 500 | 450 | MHz |
| | Simple dual-port, all supported widths | 0 | 1 | 700 | 700 | 650 | 550 | 700 | 500 | 450 | MHz |
| | Simple dual-port with the read-during-write option set to Old Data , all supported widths | 0 | 1 | 525 | 525 | 455 | 400 | 525 | 455 | 400 | MHz |
| M20K Block | Simple dual-port with ECC enabled, 512 × 32 | 0 | 1 | 450 | 450 | 400 | 350 | 450 | 400 | 350 | MHz |
| | Simple dual-port with ECC and optional pipeline registers enabled, 512 × 32 | 0 | 1 | 600 | 600 | 500 | 450 | 600 | 500 | 450 | MHz |
| - | True dual port, all supported widths | 0 | 1 | 700 | 700 | 650 | 550 | 700 | 500 | 450 | MHz |
| | ROM, all supported widths | 0 | 1 | 700 | 700 | 650 | 550 | 700 | 500 | 450 | MHz |

Table 33. Memory Block Performance Specifications for Stratix V Devices ^{(1), (2)} (Part 2 of 2)

Notes to Table 33:

(1) To achieve the maximum memory block performance, use a memory block clock that comes through global clock routing from an on-chip PLL set to **50**% output duty cycle. Use the Quartus II software to report timing for this and other memory block clocking schemes.

(2) When you use the error detection cyclical redundancy check (CRC) feature, there is no degradation in F_{MAX}.

(3) The F_{MAX} specification is only achievable with Fitter options, MLAB Implementation In 16-Bit Deep Mode enabled.

Temperature Sensing Diode Specifications

Table 34 lists the internal TSD specification.

Table 34. Internal Temperature Sensing Diode Specification

| Temperature Range | Accuracy | Offset Calibrated Option | Sampling Rate | Conversion Time | Resolution | Minimum Resolution with no Missing Codes |
|----------------------|----------|--------------------------------|----------------|--------------------|------------|---|
| -40°C to 100°C | ±8°C | No | 1 MHz, 500 KHz | < 100 ms | 8 bits | 8 bits |

Table 35 lists the specifications for the Stratix V external temperature sensing diode.

| | Table 35. | External | Temperature | Sensing Diode | e Specifications | for Stratix V Devices |
|--|-----------|----------|-------------|---------------|------------------|-----------------------|
|--|-----------|----------|-------------|---------------|------------------|-----------------------|

| Description | Min | Тур | Max | Unit |
|--|-------|-------|-------|------|
| I _{bias} , diode source current | 8 | — | 200 | μΑ |
| V _{bias,} voltage across diode | 0.3 | — | 0.9 | V |
| Series resistance | — | — | < 1 | Ω |
| Diode ideality factor | 1.006 | 1.008 | 1.010 | — |

| 0b.al | Oanditiana | C1 | | C2, C2L, I2, I2L | | C3, I3, I3L, I3YY | | | C4,I4 | | | 11 14 | | |
|---|---|-----|-----|------------------|-----|-------------------|------|-----|-------|----------|-----|-------|------|------|
| Symbol | Conditions | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Unit |
| Transmitter | | | | <u>.</u> | | | | | | <u>.</u> | | | | |
| | SERDES factor J = 3 to 10 ⁽⁹⁾ , ⁽¹¹⁾ , ⁽¹²⁾ , ⁽¹³⁾ , ⁽¹⁴⁾ , ⁽¹⁵⁾ , ⁽¹⁶⁾ | (6) | | 1600 | (6) | | 1434 | (6) | | 1250 | (6) | | 1050 | Mbps |
| | SERDES factor J ≥ 4 | | | | | | | | | | | | | |
| True Differential I/O Standards | LVDS TX with DPA ⁽¹²⁾ , ⁽¹⁴⁾ , ⁽¹⁵⁾ , ⁽¹⁶⁾ | (6) | _ | 1600 | (6) | _ | 1600 | (6) | _ | 1600 | (6) | _ | 1250 | Mbps |
| - f _{HSDR} (data rate) | SERDES factor J = 2, uses DDR Registers | (6) | | (7) | (6) | _ | (7) | (6) | _ | (7) | (6) | _ | (7) | Mbps |
| | SERDES factor J = 1, uses SDR Register | (6) | _ | (7) | (6) | _ | (7) | (6) | _ | (7) | (6) | _ | (7) | Mbps |
| Emulated Differential I/O Standards with Three External Output Resistor Networks - f _{HSDR} (data rate) ⁽¹⁰⁾ | SERDES factor J = 4 to 10 (17) | (6) | | 1100 | (6) | | 1100 | (6) | | 840 | (6) | | 840 | Mbps |
| t _{x Jitter} - True Differential I/O Standards | Total Jitter for Data Rate 600 Mbps - 1.25 Gbps | _ | | 160 | _ | _ | 160 | | | 160 | _ | _ | 160 | ps |
| | Total Jitter for Data Rate < 600 Mbps | _ | _ | 0.1 | _ | _ | 0.1 | _ | _ | 0.1 | _ | _ | 0.1 | UI |
| t _{x Jitter} - Emulated Differential I/O Standards | Total Jitter for Data Rate 600 Mbps - 1.25 Gbps | _ | | 300 | _ | | 300 | _ | _ | 300 | _ | | 325 | ps |
| with Three External Output Resistor Network | Total Jitter for Data Rate < 600 Mbps | _ | | 0.2 | | | 0.2 | | | 0.2 | _ | | 0.25 | UI |

Table 36. High-Speed I/O Specifications for Stratix V Devices ^{(1), (2)} (Part 2 of 4)

| Gumbal | Oenditione | | C1 | | C2, | C2L, I | 2, I2L | C3, | 13, I3L | ., I 3 YY | | C4,I | 4 | 11 |
|----------------------------------|--|-----|-----|-----------|-----|--------|-----------|-----|---------|------------------|-----|------|-----------|----------|
| Symbol | Conditions | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Unit |
| | SERDES factor J = 3 to 10 | (6) | _ | (8) | (6) | _ | (8) | (6) | | (8) | (6) | | (8) | Mbps |
| f _{HSDR} (data rate) | SERDES factor J = 2, uses DDR Registers | (6) | | (7) | (6) | _ | (7) | (6) | | (7) | (6) | | (7) | Mbps |
| | SERDES factor J = 1, uses SDR Register | (6) | _ | (7) | (6) | _ | (7) | (6) | | (7) | (6) | | (7) | Mbps |
| DPA Mode | | | | | | | | | | | | | | |
| DPA run length | _ | | | 1000 0 | | _ | 1000 0 | | _ | 1000 0 | | _ | 1000 0 | UI |
| Soft CDR mode |) | | | | | | | | | | | | | |
| Soft-CDR PPM tolerance | _ | _ | _ | 300 | _ | — | 300 | _ | | 300 | _ | | 300 | ± PPM |
| Non DPA Mode | • | • | | - | | - | | • | | - | | | - | - |
| Sampling Window | _ | | | 300 | | | 300 | | | 300 | | | 300 | ps |

Table 36. High-Speed I/O Specifications for Stratix V Devices ^{(1), (2)} (Part 4 of 4)

Notes to Table 36:

(1) When J = 3 to 10, use the serializer/deserializer (SERDES) block.

(2) When J = 1 or 2, bypass the SERDES block.

(3) This only applies to DPA and soft-CDR modes.

(4) Clock Boost Factor (W) is the ratio between the input data rate to the input clock rate.

(5) This is achieved by using the **LVDS** clock network.

(6) The minimum specification depends on the clock source (for example, the PLL and clock pin) and the clock routing resource (global, regional, or local) that you use. The I/O differential buffer and input register do not have a minimum toggle rate.

(7) The maximum ideal frequency is the SERDES factor (J) x the PLL maximum output frequency (fOUT) provided you can close the design timing and the signal integrity simulation is clean.

(8) You can estimate the achievable maximum data rate for non-DPA mode by performing link timing closure analysis. You must consider the board skew margin, transmitter delay margin, and receiver sampling margin to determine the maximum data rate supported.

(9) If the receiver with DPA enabled and transmitter are using shared PLLs, the minimum data rate is 150 Mbps.

(10) You must calculate the leftover timing margin in the receiver by performing link timing closure analysis. You must consider the board skew margin, transmitter channel-to-channel skew, and receiver sampling margin to determine leftover timing margin.

(11) The F_{MAX} specification is based on the fast clock used for serial data. The interface F_{MAX} is also dependent on the parallel clock domain which is design-dependent and requires timing analysis.

(12) Stratix V RX LVDS will need DPA. For Stratix V TX LVDS, the receiver side component must have DPA.

(13) Stratix V LVDS serialization and de-serialization factor needs to be x4 and above.

(14) Requires package skew compensation with PCB trace length.

(15) Do not mix single-ended I/O buffer within LVDS I/O bank.

(16) Chip-to-chip communication only with a maximum load of 5 pF.

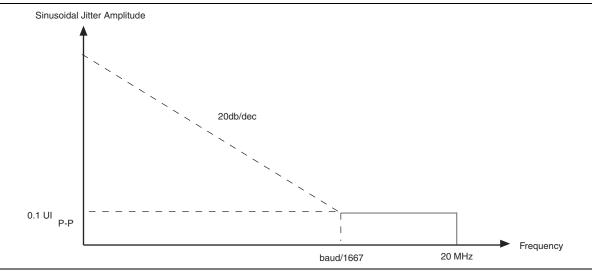
(17) When using True LVDS RX channels for emulated LVDS TX channel, only serialization factors 1 and 2 are supported.

| Jitter Fre | Sinusoidal Jitter (UI) | |
|------------|------------------------|--------|
| F1 | 10,000 | 25.000 |
| F2 | 17,565 | 25.000 |
| F3 | 1,493,000 | 0.350 |
| F4 | 50,000,000 | 0.350 |

| Table 38. | LVDS Soft-CDR/D | PA Sinusoidal | Jitter Mask Valu | es for a Data Ra | te > 1.25 Gbps |
|-----------|-----------------|---------------|-------------------------|------------------|----------------|
|-----------|-----------------|---------------|-------------------------|------------------|----------------|

Figure 9 shows the **LVDS** soft-CDR/DPA sinusoidal jitter tolerance specification for a data rate < 1.25 Gbps.





DLL Range, DQS Logic Block, and Memory Output Clock Jitter Specifications

Table 39 lists the DLL range specification for Stratix V devices. The DLL is always in 8-tap mode in Stratix V devices.

Table 39. DLL Range Specifications for Stratix V Devices (1)

| C1 | C2, C2L, I2, I2L | C3, I3, I3L, I3YY | C4,I4 | Unit |
|---------|------------------|-------------------|---------|------|
| 300-933 | 300-933 | 300-890 | 300-890 | MHz |

Note to Table 39:

(1) Stratix V devices support memory interface frequencies lower than 300 MHz, although the reference clock that feeds the DLL must be at least 300 MHz. To support interfaces below 300 MHz, multiply the reference clock feeding the DLL to ensure the frequency is within the supported range of the DLL.

Table 40 lists the DQS phase offset delay per stage for Stratix V devices.

Table 40. DQS Phase Offset Delay Per Setting for Stratix V Devices ^{(1), (2)} (Part 1 of 2)

| Speed Grade | Min | Max | Unit |
|------------------|-----|-----|------|
| C1 | 8 | 14 | ps |
| C2, C2L, I2, I2L | 8 | 14 | ps |
| C3,I3, I3L, I3YY | 8 | 15 | ps |

| Symbol | Description | Min | Max | Unit |
|-------------------|--|-----|---------------------------|------|
| t _{JPH} | JTAG port hold time | 5 | — | ns |
| t _{JPCO} | JTAG port clock to output | — | 11 ⁽¹⁾ | ns |
| t _{JPZX} | JTAG port high impedance to valid output | — | 14 ⁽¹⁾ | ns |
| t _{JPXZ} | JTAG port valid output to high impedance | — | 1 4 ⁽¹⁾ | ns |

Table 46. JTAG Timing Parameters and Values for Stratix V Devices

Notes to Table 46:

(1) A 1 ns adder is required for each V_{CCI0} voltage step down from 3.0 V. For example, $t_{JPC0} = 12$ ns if V_{CCI0} of the TDO I/O bank = 2.5 V, or 13 ns if it equals 1.8 V.

(2) The minimum TCK clock period is 167 ns if VCCBAT is within the range 1.2V-1.5V when you perform the volatile key programming.

Raw Binary File Size

For the POR delay specification, refer to the "POR Delay Specification" section of the "Configuration, Design Security, and Remote System Upgrades in Stratix V Devices".

Table 47 lists the uncompressed raw binary file (.rbf) sizes for Stratix V devices.

| Family | Device | Package | Configuration .rbf Size (bits) | IOCSR .rbf Size (bits) ^{(4), (5)} |
|--------------|--------|------------------------------|--------------------------------|--|
| | ECCVA2 | H35, F40, F35 ⁽²⁾ | 213,798,880 | 562,392 |
| | 5SGXA3 | H29, F35 ⁽³⁾ | 137,598,880 | 564,504 |
| | 5SGXA4 | _ | 213,798,880 | 563,672 |
| | 5SGXA5 | _ | 269,979,008 | 562,392 |
| | 5SGXA7 | _ | 269,979,008 | 562,392 |
| Stratix V GX | 5SGXA9 | _ | 342,742,976 | 700,888 |
| | 5SGXAB | _ | 342,742,976 | 700,888 |
| | 5SGXB5 | _ | 270,528,640 | 584,344 |
| | 5SGXB6 | _ | 270,528,640 | 584,344 |
| | 5SGXB9 | _ | 342,742,976 | 700,888 |
| | 5SGXBB | _ | 342,742,976 | 700,888 |
| Stratix V GT | 5SGTC5 | _ | 269,979,008 | 562,392 |
| | 5SGTC7 | — | 269,979,008 | 562,392 |
| | 5SGSD3 | _ | 137,598,880 | 564,504 |
| | 5SGSD4 | F1517 | 213,798,880 | 563,672 |
| Ctratic V CC | 556504 | _ | 137,598,880 | 564,504 |
| Stratix V GS | 5SGSD5 | _ | 213,798,880 | 563,672 |
| | 5SGSD6 | _ | 293,441,888 | 565,528 |
| | 5SGSD8 | _ | 293,441,888 | 565,528 |

Table 47. Uncompressed .rbf Sizes for Stratix V Devices

| Family | Device | Package | Configuration .rbf Size (bits) | IOCSR .rbf Size (bits) ^{(4), (5)} |
|-----------------|--------|---------|--------------------------------|--|
| Stratix V E (1) | 5SEE9 | — | 342,742,976 | 700,888 |
| | 5SEEB | _ | 342,742,976 | 700,888 |

Table 47. Uncompressed .rbf Sizes for Stratix V Devices

Notes to Table 47:

(1) Stratix V E devices do not have PCI Express® (PCIe®) hard IP. Stratix V E devices do not support the CvP configuration scheme.

(2) 36-transceiver devices.

(3) 24-transceiver devices.

(4) File size for the periphery image.

(5) The IOCSR .rbf size is specifically for the CvP feature.

Use the data in Table 47 to estimate the file size before design compilation. Different configuration file formats, such as a hexadecimal (.hex) or tabular text file (.ttf) format, have different file sizes. For the different types of configuration file and file sizes, refer to the Quartus II software. However, for a specific version of the Quartus II software, any design targeted for the same device has the same uncompressed configuration file size. If you are using compression, the file size can vary after each compilation because the compression ratio depends on your design.

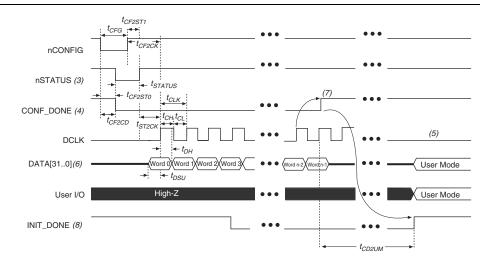
• For more information about setting device configuration options, refer to *Configuration, Design Security, and Remote System Upgrades in Stratix V Devices.* For creating configuration files, refer to the *Quartus II Help.*

Table 48 lists the minimum configuration time estimates for Stratix V devices.

| Variant | Member | Active Serial ⁽¹⁾ | | | Fast Passive Parallel ⁽²⁾ | | |
|---------|----------------|------------------------------|------------|------------------------|--------------------------------------|------------|------------------------|
| | Member Code | Width | DCLK (MHz) | Min Config Time (s) | Width | DCLK (MHz) | Min Config Time (s) |
| | A3 | 4 | 100 | 0.534 | 32 | 100 | 0.067 |
| | AS | 4 | 100 | 0.344 | 32 | 100 | 0.043 |
| | A4 | 4 | 100 | 0.534 | 32 | 100 | 0.067 |
| | A5 | 4 | 100 | 0.675 | 32 | 100 | 0.084 |
| | A7 | 4 | 100 | 0.675 | 32 | 100 | 0.084 |
| GX | A9 | 4 | 100 | 0.857 | 32 | 100 | 0.107 |
| | AB | 4 | 100 | 0.857 | 32 | 100 | 0.107 |
| | B5 | 4 | 100 | 0.676 | 32 | 100 | 0.085 |
| | B6 | 4 | 100 | 0.676 | 32 | 100 | 0.085 |
| | B9 | 4 | 100 | 0.857 | 32 | 100 | 0.107 |
| | BB | 4 | 100 | 0.857 | 32 | 100 | 0.107 |
| ст | C5 | 4 | 100 | 0.675 | 32 | 100 | 0.084 |
| GT | C7 | 4 | 100 | 0.675 | 32 | 100 | 0.084 |

FPP Configuration Timing when DCLK-to-DATA [] = 1

Figure 12 shows the timing waveform for FPP configuration when using a MAX II or MAX V device as an external host. This waveform shows timing when the DCLK-to-DATA[] ratio is 1.





Notes to Figure 12:

- (1) Use this timing waveform when the DCLK-to-DATA [] ratio is 1.
- (2) The beginning of this waveform shows the device in user mode. In user mode, nCONFIG, nSTATUS, and CONF_DONE are at logic-high levels. When nCONFIG is pulled low, a reconfiguration cycle begins.
- (3) After power-up, the Stratix V device holds nstatus low for the time of the POR delay.
- (4) After power-up, before and during configuration, CONF_DONE is low.
- (5) Do not leave DCLK floating after configuration. DCLK is ignored after configuration is complete. It can toggle high or low if required.
- (6) For FPP ×16, use DATA [15..0]. For FPP ×8, use DATA [7..0]. DATA [31..0] are available as a user I/O pin after configuration. The state of this pin depends on the dual-purpose pin settings.
- (7) To ensure a successful configuration, send the entire configuration data to the Stratix V device. CONF_DONE is released high when the Stratix V device receives all the configuration data successfully. After CONF_DONE goes high, send two additional falling edges on DCLK to begin initialization and enter user mode.
- (8) After the option bit to enable the INIT_DONE pin is configured into the device, the INIT DONE goes low.

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Table 51 lists the timing parameters for Stratix V devices for FPP configuration when the DCLK-to-DATA[] ratio is more than 1.

| Symbol | Parameter | Minimum | Maximum | Units |
|-----------------------------------|---|---|----------------------|-------|
| t _{CF2CD} | nCONFIG low to CONF_DONE low | — | 600 | ns |
| t _{CF2ST0} | nCONFIG low to nSTATUS low | — | 600 | ns |
| t _{CFG} | nCONFIG low pulse width | 2 | _ | μS |
| t _{STATUS} | nSTATUS low pulse width | 268 | 1,506 ⁽²⁾ | μS |
| t _{CF2ST1} | nCONFIG high to nSTATUS high | — | 1,506 ⁽²⁾ | μS |
| t _{CF2CK} ⁽⁵⁾ | nCONFIG high to first rising edge on DCLK | 1,506 | _ | μS |
| t _{ST2CK} ⁽⁵⁾ | nSTATUS high to first rising edge of DCLK | 2 | — | μS |
| t _{DSU} | DATA [] setup time before rising edge on DCLK | 5.5 | | ns |
| t _{DH} | DATA [] hold time after rising edge on DCLK | N-1/f _{DCLK} ⁽⁵⁾ | | S |
| t _{CH} | DCLK high time | $0.45 	imes 1/f_{MAX}$ | | S |
| t _{CL} | DCLK low time | $0.45\times1/f_{MAX}$ | | S |
| t _{CLK} | DCLK period | 1/f _{MAX} | | S |
| f | DCLK frequency (FPP ×8/×16) | — | 125 | MHz |
| f _{MAX} | DCLK frequency (FPP ×32) | — | 100 | MHz |
| t _R | Input rise time | — | 40 | ns |
| t _F | Input fall time | — | 40 | ns |
| t _{CD2UM} | CONF_DONE high to user mode ⁽³⁾ | 175 | 437 | μS |
| t _{CD2CU} | CONF_DONE high to CLKUSR enabled | 4 × maximum DCLK period | _ | _ |
| t _{CD2UMC} | CONF_DONE high to user mode with CLKUSR option on | t_{CD2CU} + (8576 × CLKUSR period) ⁽⁴⁾ | _ | _ |

Notes to Table 51:

- (1) Use these timing parameters when you use the decompression and design security features.
- (2) You can obtain this value if you do not delay configuration by extending the nCONFIG or nSTATUS low pulse width.
- (3) The minimum and maximum numbers apply only if you use the internal oscillator as the clock source for initializing the device.
- (4) To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on these pins, refer to the Initialization section of the "Configuration, Design Security, and Remote System Upgrades in Stratix V Devices" chapter.
- (5) N is the ${\tt DCLK}\mbox{-to-DATA}$ ratio and $f_{{\tt DCLK}}$ is the ${\tt DCLK}$ frequency the system is operating.
- (6) If nSTATUS is monitored, follow the t_{ST2CK} specification. If nSTATUS is not monitored, follow the t_{CF2CK} specification.

Active Serial Configuration Timing

Table 52 lists the DCLK frequency specification in the AS configuration scheme.

| Table 52. | DCLK Frequency | Specification in the <i>l</i> | AS Configuration Scheme | (1), (2) |
|-----------|----------------|-------------------------------|-------------------------|----------|
|-----------|----------------|-------------------------------|-------------------------|----------|

| Minimum | Typical | Maximum | Unit |
|---------|---------|---------|------|
| 5.3 | 7.9 | 12.5 | MHz |
| 10.6 | 15.7 | 25.0 | MHz |
| 21.3 | 31.4 | 50.0 | MHz |
| 42.6 | 62.9 | 100.0 | MHz |

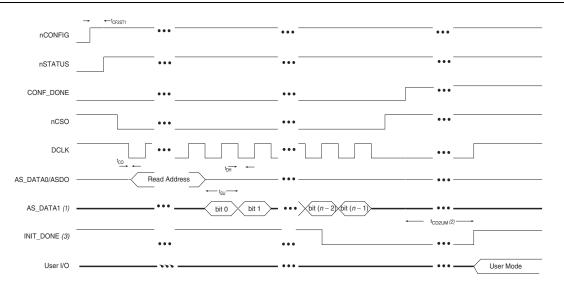
Notes to Table 52:

(1) This applies to the DCLK frequency specification when using the internal oscillator as the configuration clock source.

(2) The AS multi-device configuration scheme does not support DCLK frequency of 100 MHz.

Figure 14 shows the single-device configuration setup for an AS ×1 mode.





Notes to Figure 14:

- (1) If you are using AS $\times 4$ mode, this signal represents the AS_DATA[3..0] and EPCQ sends in 4-bits of data for each DCLK cycle.
- (2) The initialization clock can be from internal oscillator or CLKUSR pin.
- (3) After the option bit to enable the INIT_DONE pin is configured into the device, the INIT_DONE goes low.

Table 53 lists the timing parameters for AS $\times 1$ and AS $\times 4$ configurations in Stratix V devices.

| Symbol | Parameter | Minimum | Maximum | Units |
|-----------------|---|---------|---------|-------|
| t _{CO} | DCLK falling edge to AS_DATA0/ASDO output | — | 2 | ns |
| t _{SU} | Data setup time before falling edge on DCLK | 1.5 | _ | ns |
| t _H | Data hold time after falling edge on DCLK | 0 | — | ns |

Table 60. Glossary (Part 2 of 4)

| Letter | Subject | Definitions |
|-----------------------|------------------------------------|--|
| G | | |
| Н | _ | _ |
| Ι | | |
| J | J JTAG Timing Specifications | High-speed I/O block—Deserialization factor (width of parallel data bus). JTAG Timing Specifications: TMS TDI t_{JCP} t_{JCH} t_{JCH} t_{JPCO} t_{JPCO} t_{JPXZ} TDO t_{JPXZ} t_{JPXZ} |
| K L M N O | _ | _ |
| Ρ | PLL Specifications | Diagram of PLL Specifications (1) |
| Q | | _ |
| | 1 | |

Table 61. Document Revision History (Part 2 of 3)

| Date | Version | Changes |
|---------------|---------|---|
| | | Added the I3YY speed grade and changed the data rates for the GX channel in Table 1. |
| | | Added the I3YY speed grade to the V_{CC} description in Table 6. |
| | | Added the I3YY speed grade to V_{CCHIP_L}, V_{CCHIP_R}, V_{CCHSSI_L}, and V_{CCHSSI_R} descriptions in Table 7. |
| | | ■ Added 240-Ω to Table 11. |
| | | Changed CDR PPM tolerance in Table 23. |
| | | Added additional max data rate for fPLL in Table 23. |
| | | Added the I3YY speed grade and changed the data rates for transceiver speed grade 3 in Table 25. |
| | | Added the I3YY speed grade and changed the data rates for transceiver speed grade 3 in Table 26. |
| | | Changed CDR PPM tolerance in Table 28. |
| | | Added additional max data rate for fPLL in Table 28. |
| | | Changed the mode descriptions for MLAB and M20K in Table 33. |
| | | ■ Changed the Max value of f _{HSCLK_OUT} for the C2, C2L, I2, I2L speed grades in Table 36. |
| November 2014 | 4 3.3 | Changed the frequency ranges for C1 and C2 in Table 39. |
| | | Changed the .rbf file sizes for 5SGSD6 and 5SGSD8 in Table 47. |
| | | Added note about nSTATUS to Table 50, Table 51, Table 54. |
| | | Changed the available settings in Table 58. |
| | | Changed the note in "Periphery Performance". |
| | | Updated the "I/O Standard Specifications" section. |
| | | Updated the "Raw Binary File Size" section. |
| | | Updated the receiver voltage input range in Table 22. |
| | | Updated the max frequency for the LVDS clock network in Table 36. |
| | | ■ Updated the DCLK note to Figure 11. |
| | | Updated Table 23 VO_{CM} (DC Coupled) condition. |
| | | Updated Table 6 and Table 7. |
| | | ■ Added the DCLK specification to Table 55. |
| | | Updated the notes for Table 47. |
| | | Updated the list of parameters for Table 56. |
| November 2013 | 3.2 | Updated Table 28 |
| November 2013 | 3.1 | Updated Table 33 |
| November 2013 | 3.0 | Updated Table 23 and Table 28 |
| October 2013 | 2.9 | Updated the "Transceiver Characterization" section |
| | 2.8 | Updated Table 3, Table 12, Table 14, Table 19, Table 20, Table 23, Table 24, Table 28, Table 30, Table 31, Table 32, Table 33, Table 36, Table 39, Table 40, Table 41, Table 42, Table 47, Table 53, Table 58, and Table 59 |
| October 2013 | | Added Figure 1 and Figure 3 |
| | | Added the "Transceiver Characterization" section |
| | | Removed all "Preliminary" designations. |